## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s):

R. Scott LIST et al.

Serial No.:

Divisional of Application No. 10/066,668

filed on February 6, 2002

Filed:

July 7, 2003

For:

A BARRIER STRUCTURE AGAINST CORROSION AND CONTAMINATION

IN THREE-DIMENSIONAL (3-D) WAFER-TO-WAFER VERTICAL STACK

Group:

Not Yet Assigned

## INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR §1.97 & §1.98

Assistant Commissioner of Patents Washington, D.C. 20231

July 7, 2003

Sir:

In the matter of the above-identified application, this Information Disclosure Statement is being submitted with the following citation as specified in 37 CFR §1.97(d).

"A copy of any patent, publication or other information listed in an Information Disclosure Statement is not required to be provided if it was previously cited by or submitted to the Office in a prior application, provided that the prior application is properly identified in the statement and relied upon for an earlier filing date under 35 U.S.C. §120."

Applicant(s) are submitting herewith a copy of Form PTO-1449 which list documents cited in parent application(s) Serial No. 10/066,668, filed February 6, 2002.

It is respectfully requested that this information disclosure statement be considered by the Examiner.

Please charge any shortage in the fees due in connection with the filing of this paper, including extension of time fees, to the deposit account of Antonelli, Terry, Stout & Kraus Deposit

Account No. 01-2135 (219.40603VX1) please credit any excess fees to such deposit account.

Respectfully submitted,

Hung H. Bui Registration No. 40,415
ANTONELLI, TERRY, STOUT & KRAUS, LLP

HHB/slh

U.S. Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE

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	Substitute for form 1449A/PTO				Complete if Known		
	INFORMATION DISCLOSURE STATEMENT BY APPLICANT  (use as many sheets as necessary)				Application Number Filing Date	Divisional of Application No. 10/066,668 July 7, 2003	
					First Named Inventor	R. Scott LIST	
					Art Unit	Not Yet Assigned	
					Examiner Name	Not Yet Assigned	
Sheet	1	of	2		Attorney Docket Number	219.40603VX1	

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Examiner Initials'	Cite No. <sup>1</sup>	Document Number	Publication Date  MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
		Number-Kind Code <sup>2</sup> (if known)			
		US 4,689,113	08/1987	Balasubramanyam et al.	
		US 5,366,906	11/1994	Wajnarowski et al.	
		US 5,241,450	08/1993	Bernhardt et al.	
		US 5,419,806	05/1995	Huebner, Holger	
		US 5,880,010	03/1999	Davidson, Howard L.	
		US 6,255,726	07/2001	Vindasius et al.	
		US 6,355,501	03/2002	Fung et al.	
		US 6,355,976	03/2002	Faris, Sadeg M.	
-					

	FOREIGN PATENT DOCUMENTS						
Examiner Initials'	Cite	Foreign Patent Document	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear		
	No. <sup>1</sup>	Country Code <sup>3</sup> –Number <sup>4</sup> –Kind Code <sup>5</sup> (if known)				T <sup>6</sup>	
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<sup>\*</sup>EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

<sup>&</sup>lt;sup>1</sup>Applicant's unique citation designation number (optional). <sup>2</sup>See Kinds Codes of USPTO Patent Documents at <a href="https://www.uspto.gov">www.uspto.gov</a> or MPEP 901.04. <sup>3</sup>Enter Office that issued the document, by the two-letter code (WIPO Standard St.3). <sup>4</sup>For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>5</sup>Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. <sup>6</sup>Applicant is to place a check mark here if English language Translation is attached.

PTO/SB/08A (10-01)

Approved for use through 10/31/2002. OMB 0651-0031

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Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it contains a valid OMB control number. Complete if Known Substitute for form 1449B/PTO **Application Number** Divisional of Application No. INFORMATION DISCLOSURE 10/066,668 STATEMENT BY APPLICANT Filing Date July 7, 2003 First Named Inventor R. Scott LIST (use as many sheets as necessary) Group Art Unit Not Yet Assigned Examiner Name Not Yet Assigned Sheet 2 of 2 Attorney Docket Number 219.40603VX1

Examiner Initials*	Cite No. <sup>1</sup>	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T <sup>2</sup>
		"Ultra Thin Electronics for Space Applications", 2001 Electronic Components and Technology Conference, 2001 IEEE	
		Copper Wafer Bonding"; A. Fan, A. Rahman, and R. Reif; Electrochemical and Solid-State Letters, 2 (10) 534-536 (1999)	
		"Face to Face Wafer Bonding for 3D Chip Stack Fabrication to Shorten Wire Lengths", June 27-29, 2000 VMIC Conference 2000 IMIC – 200/00/0090(c)	
		"InterChip Via Technology for Vertical System Integration", Fraunhofer Institute for Reliability and Microintegration, Munich, Germany; Infineon Technologies AG, Munich, Germany; 2001 IEEE	
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